

# **CORROSION PREVENTION ON COPPER**

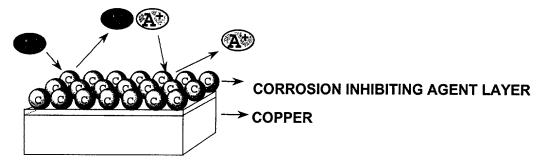
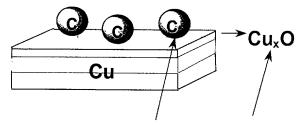


FIGURE 1

#### ATMI-0396 CIP II Sheet 2 of 6

# **CONTAMINATION TEST**

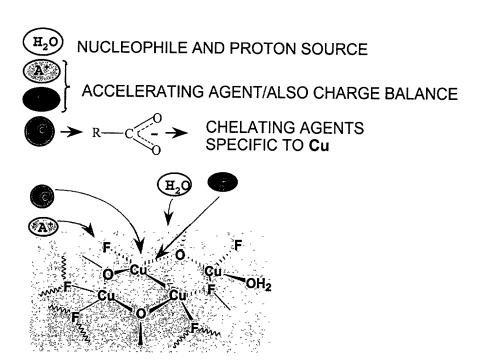


SAMPLE**	Cu (atoms/cm <sup>2</sup> )	F (atoms/cm <sup>2</sup> )	C (atoms/cm <sup>2</sup> )	Cu <sub>x</sub> O (Å)
CONTROL	1.6 x 10 <sup>10</sup>	$3.3 \times 10^{13}$	$7.5 \times 10^{13}$	42
Matrix 2 + IMINODIACETIC ACID.INHIBITOR	8.5 x 10°	5.1 x 10 <sup>13</sup>	1.5 x 10 <sup>13</sup>	15

<sup>\*</sup> Blanket Cu and Si Films Processed Together, 20 mL of Chemical (25 °C @ 15 min, DI Water Rinse)

### FIGURE 2

<sup>\*\*</sup> Average of 3 Points



**INSOLUBLE INORGANIC SLURRY AND RESIDUES** 

### FIGURE 3

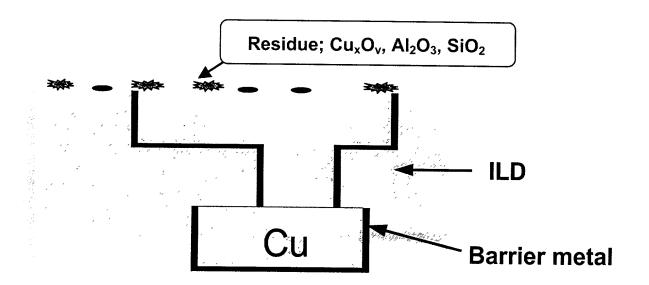


FIGURE 4

#### ATMI-0396 CIP II Sheet 5 of 6

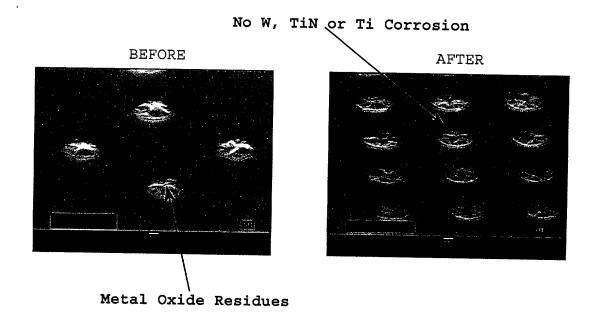


FIGURE 5

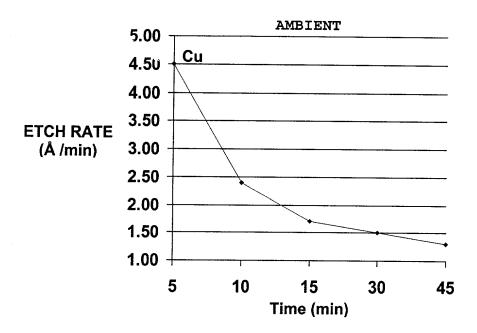


FIGURE 6